



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
SENSITIVE
DEVICES



CAUTION

This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL

3

1. Calculated shelf life in sealed bag: 12 months at $< 40^{\circ}\text{C}$ and $< 90\%$ relative humidity (RH)
2. Peak package body temperature: 260°C
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must
a) Mounted within: 168 hours of factory
If blank, see adjacent bar code label
conditions $\leq 30^{\circ}\text{C}/60\%$
b) Stored at $< 10\%$ RH
4. Devices require bake, before mounting, if:
a) Humidity Indicator Card is $> 10\%$ when read at $23 \pm 5^{\circ}\text{C}$
b) 3a or 3b not met
5. If baking is required, devices may be baked for 48 hours at $125 \pm 5^{\circ}\text{C}$
Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure
Bag Seal Date: _____
If blank, see adjacent bar code label
Note: Level and body temperature defined by IPC/JEDEC J-STD-020



平芯微

Wuxi PWCHIP Semi Technology CO., LTD

Product: PW5100-33

Lot No: AXh23999g

D/C: 2348

QTY: 3000

Date: 2023/11/22



夸克微科技

ROHS



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